

ASX RELEASE

23 March 2023

NOTICE UNDER SECTION 708A OF THE CORPORATIONS ACT

This notice is given by 4DS Memory Limited (“Issuer”) under section 708A(5)(e) of the *Corporations Act 2001* (Cth) (“Act”).

The Issuer advises that it has today issued 152,777,778 fully paid ordinary shares in the capital of the Company (“Shares”), at an issue price of \$0.036 per Share and 76,388,882 free attaching unlisted options (exercisable at \$0.055 and expiring 31 March 2026) to sophisticated and professional investors, pursuant to the placement announced on 20 March 2023 (“Placement”).

The Issuer also issued 10,000,000 unlisted options (exercisable at \$0.055 and expiring 31 March 2026) to 180 Markets Pty Ltd in consideration for services provided by 180 Markets Pty Ltd as the lead manager to the Placement.

Pursuant to section 708A(5)(e) of the Act, the Issuer gives notice that:

- a) the Shares were issued without disclosure to investors under Part 6D.2 of the Act;
- b) as at the date of this notice, the Issuer has complied with:
 - i. the provisions of Chapter 2M of the Act, as they apply to the Issuer; and
 - ii. section 674 of the Act; and
- c) as at the date of this notice, there is no information that is ‘excluded information’ within the meaning of sections 708A(7) and 708A(8) of the Act which is required to be disclosed by the Issuer.

Authorised for release by the 4DS Board.

ENDS**Contact information**

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About 4DS

4DS Memory Limited (ASX: 4DS), with facilities located in Silicon Valley, is a semiconductor development company of non-volatile memory technology, pioneering Interface Switching ReRAM for next generation gigabyte storage in mobile and cloud. Established in 2007, 4DS owns a patented IP portfolio, comprising 34 USA patents granted which has been developed in-house to create high-density Storage Class Memory. 4DS has a joint development agreement with Western Digital subsidiary HGST, a global storage leader, which accelerates the evolution of 4DS’ technology. 4DS also collaborates with imec, a world-leading research and innovation hub in nanoelectronics and digital technologies. The combination of imec’s widely acclaimed leadership in microchip technology and profound software and information and communication technology expertise makes them unique.

For more information, please visit www.4dsmemory.com.